

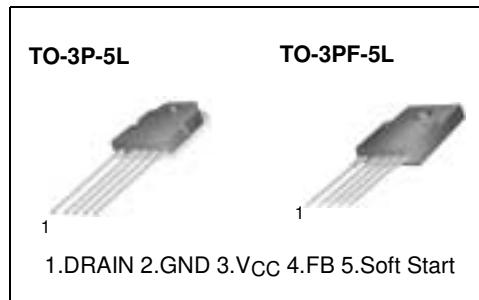
# KA1M0680B/KA1M0680RB/ KA1H0680B/KA1H0680RFB Fairchild Power Switch(FPS)

## Features

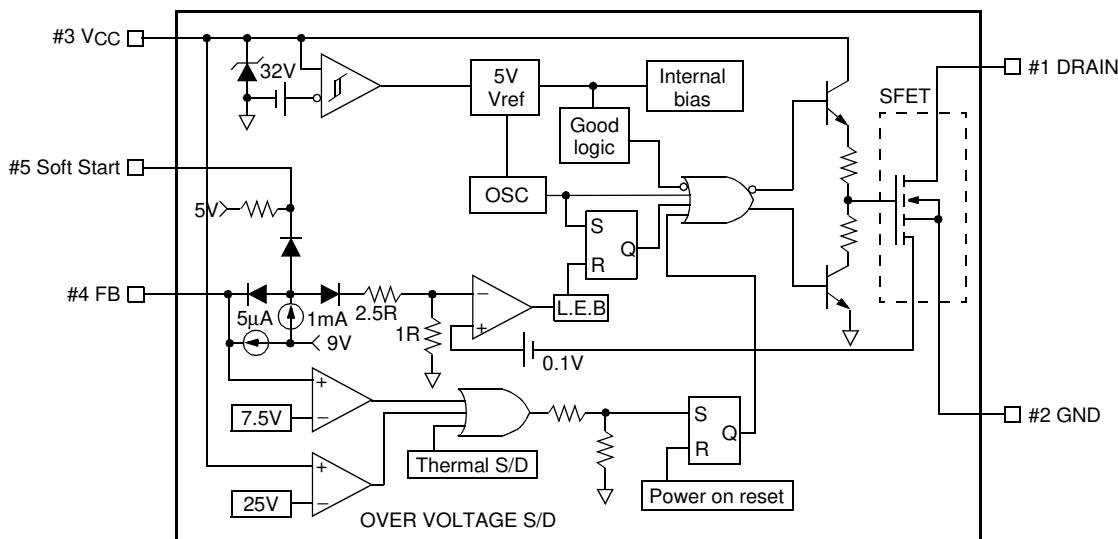
- Precision fixed operating frequency
- KA1M0680B,KA1M0680RB (67KHz)
- KA1H0680B,KA1H0680RFB (100KHz)
- Pulse by pulse over current limiting
- Over load protection
- Over voltage protection (Min. 23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET
- Latch up mode (KA1M0680B,KA1H0680B)
- Auto restart (KA1M0680RB,KA1H0680RFB)
- Soft start

## Description

The Fairchild Power Switch(FPS) product family is specially designed for an off-line SMPS with minimal external components. The Fairchild Power Switch(FPS) consist of high voltage power SenseFET and current mode PWM controller IC. PWM controller features integrated fixed oscillator, under voltage lock out, leading edge blanking, optimized gate turn-on/turn-off driver, thermal shut down protection, over voltage protection, temperature compensated precision current sources for loop compensation and fault protection circuit. compared to discrete MOSFET and controller or RCC switching converter solution, a Fairchild Power Switch(FPS) can reduce total component count, design size, weight and at the same time increase & efficiency, productivity, and system reliability. It has a basic platform well suited for cost effective design in either a flyback converter or a forward converter.



## Internal Block Diagram



## Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Maximum Drain voltage <sup>(1)</sup>	V <sub>D,MAX</sub>	800	V
Drain Gate voltage ( $R_{GS}=1M\Omega$ )	V <sub>DGR</sub>	800	V
Gate source (GND) voltage	V <sub>GS</sub>	$\pm 30$	V
Drain current pulsed <sup>(2)</sup>	I <sub>DM</sub>	24.0	ADC
Single pulsed avalanche energy <sup>(3)</sup>	E <sub>AS</sub>	455	mJ
Avalanche current <sup>(4)</sup>	I <sub>AS</sub>	16	A
Continuous drain current ( $T_C=25^\circ C$ )	I <sub>D</sub>	6.0	ADC
Continuous drain current ( $T_C=100^\circ C$ )	I <sub>D</sub>	4.0	ADC
Maximum Supply voltage	V <sub>CC,MAX</sub>	30	V
Input voltage range	V <sub>FB</sub>	-0.3 to V <sub>SD</sub>	V
Total power dissipation	P <sub>D</sub>	150	W
	Derating	1.21	W/ $^\circ C$
Operating ambient temperature	T <sub>A</sub>	-25 to +85	$^\circ C$
Storage temperature	T <sub>STG</sub>	-55 to +150	$^\circ C$

**Notes:**

1.  $T_j=25^\circ C$  to  $150^\circ C$
2. Repetitive rating: Pulse width limited by maximum junction temperature
3.  $L=24mH$ ,  $V_{DD}=50V$ ,  $R_G=25\Omega$ , starting  $T_j=25^\circ C$
4.  $L=13\mu H$ , starting  $T_j=25^\circ C$

## Electrical Characteristics (SFET part)

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain source breakdown voltage	BVDSS	VGS=0V, ID=50µA	800	-	-	V
Zero gate voltage drain current	IDSS	VDS=Max., Rating, VGS=0V	-	-	50	µA
		VDS=0.8Max., Rating, VGS=0V, TC=125°C	-	-	200	µA
Static drain source on resistance <sup>(note)</sup>	RDS(ON)	VGS=10V, ID=4.0A	-	1.6	2.0	Ω
Forward transconductance <sup>(note)</sup>	gfs	VDS=15V, ID=4.0A	1.5	2.5	-	S
Input capacitance	Ciss	VGS=0V, VDS=25V, f=1MHz	-	1600	-	pF
Output capacitance	Coss		-	140	-	
Reverse transfer capacitance	Crss		-	42	-	
Turn on delay time	td(on)	VDD=0.5BVDS, ID=6.0A (MOSFET switching time are essentially independent of operating temperature)	-	60	-	nS
Rise time	tr		-	150	-	
Turn off delay time	td(off)		-	300	-	
Fall time	tf		-	130	-	
Total gate charge (gate-source+gate-drain)	Qg	VGS=10V, ID=6.0A, VDS=0.5BVDS (MOSFET switching time are essentially independent of operating temperature)	-	70	-	nC
Gate source charge	Qgs		-	16	-	
Gate drain (Miller) charge	Qgd		-	27	-	

**Note:**

Pulse test: Pulse width ≤ 300µS, duty cycle ≤ 2%

$$S = \frac{1}{R}$$

## Electrical Characteristics (CONTROL part)

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
<b>UVLO SECTION</b>						
Start threshold voltage	VSTART	-	14	15	16	V
Stop threshold voltage	VSTOP	After turn on	9	10	11	V
<b>OSCILLATOR SECTION</b>						
Initial accuracy	FOSC	KA1M0680B	61	67	73	kHz
		KA1M0680RB	61	67	73	
		KA1H0680B	90	100	110	
		KA1H0680RFB	90	100	110	
Frequency change with temperature <sup>(2)</sup>	ΔF/ΔT	-25°C ≤ Ta ≤ +85°C	-	±5	±10	%
Maximum duty cycle	Dmax	KA1M0680B	74	77	80	%
		KA1M0680RB	74	77	80	
		KA1H0680B	64	67	70	
		KA1H0680RFB	64	67	70	
<b>FEEDBACK SECTION</b>						
Feedback source current	I <sub>FB</sub>	Ta=25°C, 0V ≤ V <sub>fb</sub> ≤ 3V	0.7	0.9	1.1	mA
Shutdown Feedback voltage	V <sub>SD</sub>	-	6.9	7.5	8.1	V
Shutdown delay current	I <sub>delay</sub>	Ta=25°C, 5V ≤ V <sub>fb</sub> ≤ V <sub>SD</sub>	4.0	5.0	6.0	μA
<b>SOFT START SECTION</b>						
Soft Start Voltage	V <sub>SS</sub>	V <sub>FB</sub> =2V	4.7	5.0	5.3	V
Soft Start Current	I <sub>SS</sub>	Sync & S/S=GND	0.8	1.0	1.2	mA
<b>REFERENCE SECTION</b>						
Output voltage <sup>(1)</sup>	V <sub>ref</sub>	Ta=25°C	4.80	5.00	5.20	V
Temperature Stability <sup>(1)(2)</sup>	V <sub>ref</sub> /ΔT	-25°C ≤ Ta ≤ +85°C	-	0.3	0.6	mV/°C
<b>CURRENT LIMIT (SELF-PROTECTION) SECTION</b>						
Peak Current Limit	I <sub>OVER</sub>	Max. inductor current	3.52	4.00	4.48	A
<b>PROTECTION SECTION</b>						
Thermal shutdown temperature (T <sub>j</sub> ) <sup>(1)</sup>	T <sub>SD</sub>	-	140	160	-	°C
Over voltage protection voltage	V <sub>OVP</sub>	-	23	25	28	V
<b>TOTAL DEVICE SECTION</b>						
Start Up current	I <sub>START</sub>	V <sub>CC</sub> =14V	0.1	0.3	0.45	mA
Operating supply current (control part only)	I <sub>OP</sub>	Ta=25°C	6	12	18	mA
V <sub>CC</sub> zener voltage	V <sub>Z</sub>	I <sub>CC</sub> =20mA	30	32.5	35	V

**Note:**

- These parameters, although guaranteed, are not 100% tested in production
- These parameters, although guaranteed, are tested in EDS (wafer test) process

## Typical Performance Characteristics

(These characteristic graphs are normalized at  $T_a=25^\circ\text{C}$ )

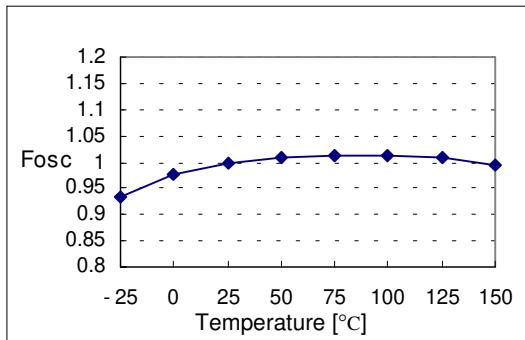


Figure 1. Operating Frequency

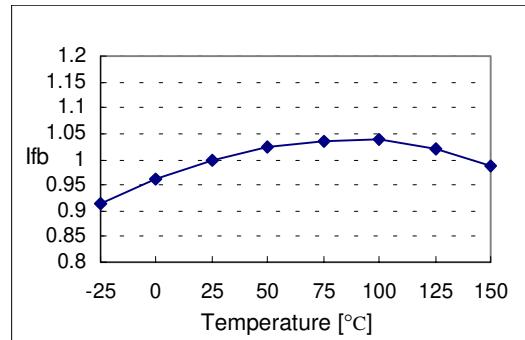


Figure 2. Feedback Source Current

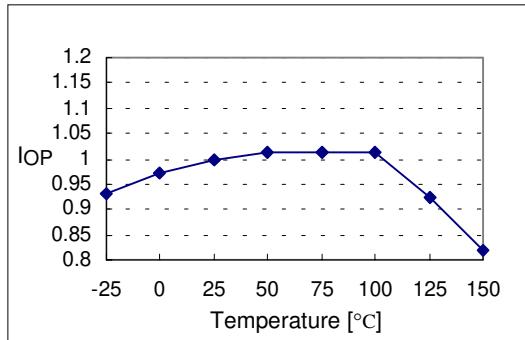


Figure 3. Operating Supply Current

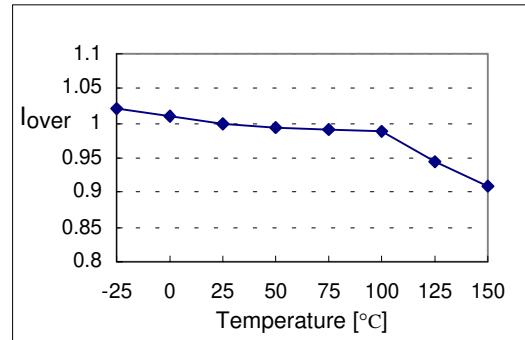


Figure 4. Peak Current Limit

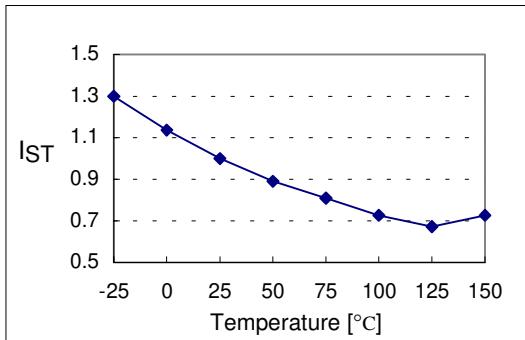


Figure 5. Start up Current

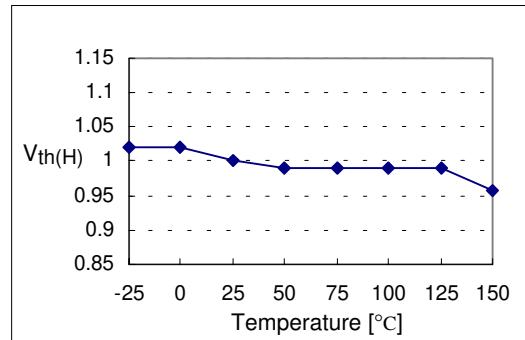


Figure 6. Start Threshold Voltage

## Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at  $T_a=25^\circ\text{C}$ )

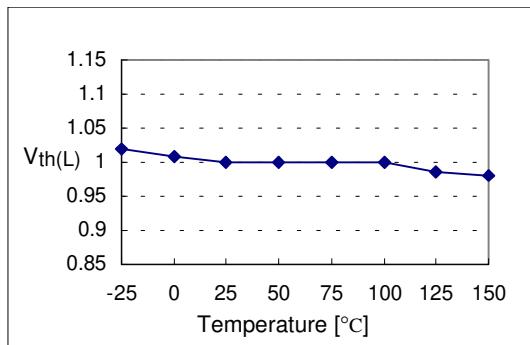


Figure 7. Stop Threshold Voltage

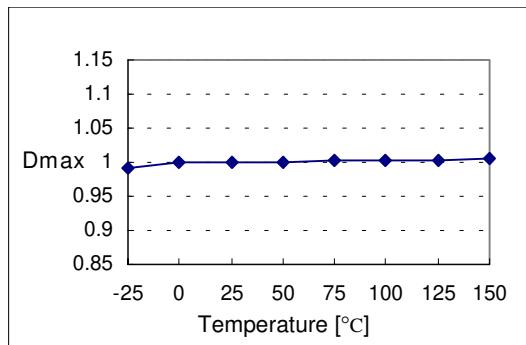


Figure 8. Maximum Duty Cycle

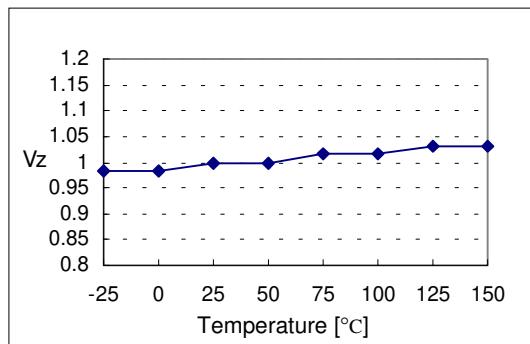


Figure 9. VCC Zener Voltage

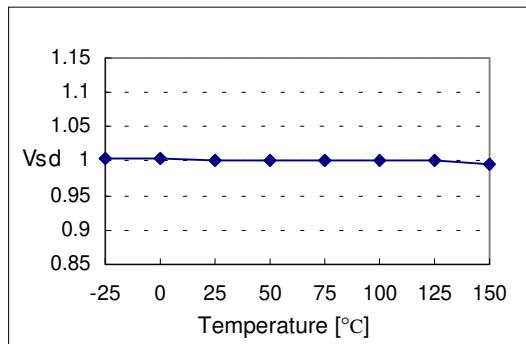


Figure 10. Shutdown Feedback Voltage

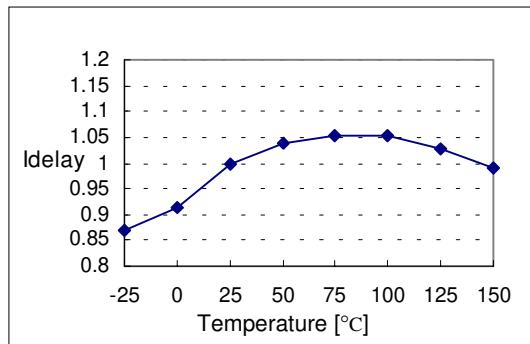


Figure 11. Shutdown Delay Current

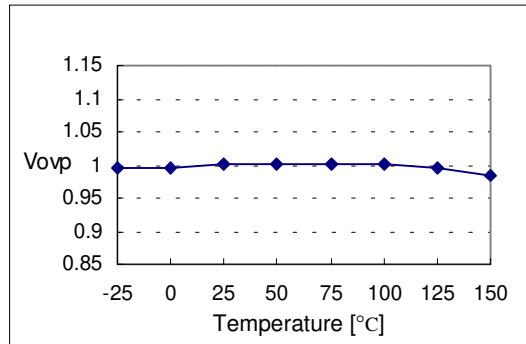


Figure 12. Over Voltage Protection

## Typical Performance Characteristics (Continued)

(These characteristic graphs are normalized at  $T_a=25^{\circ}\text{C}$ )

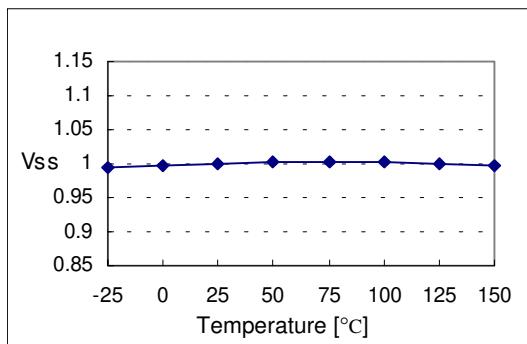


Figure 13. Soft Start Voltage

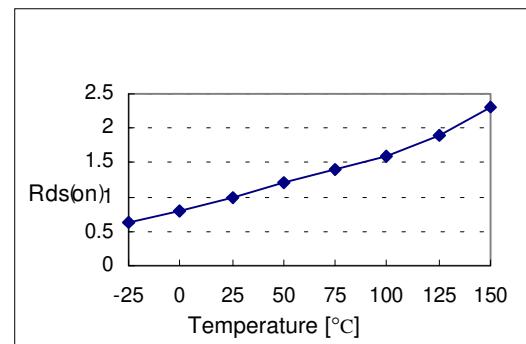
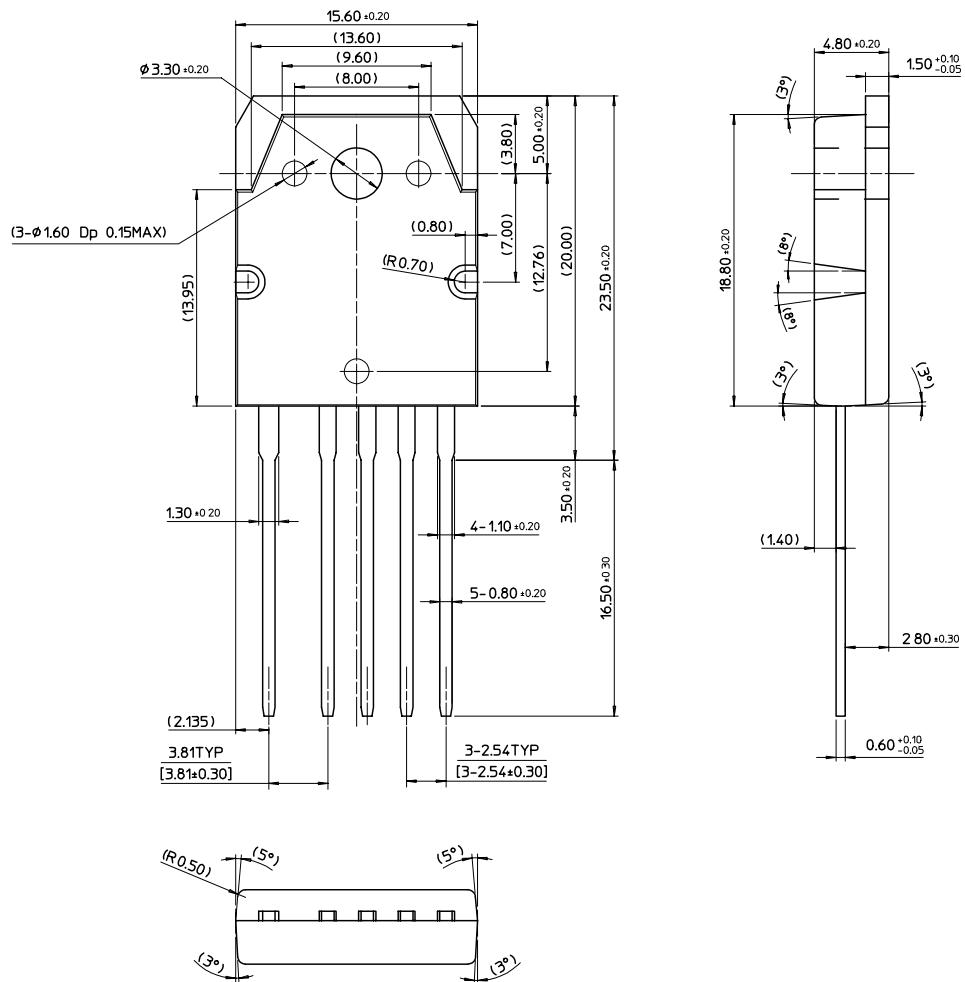


Figure 14. Static Drain-Source on Resistance

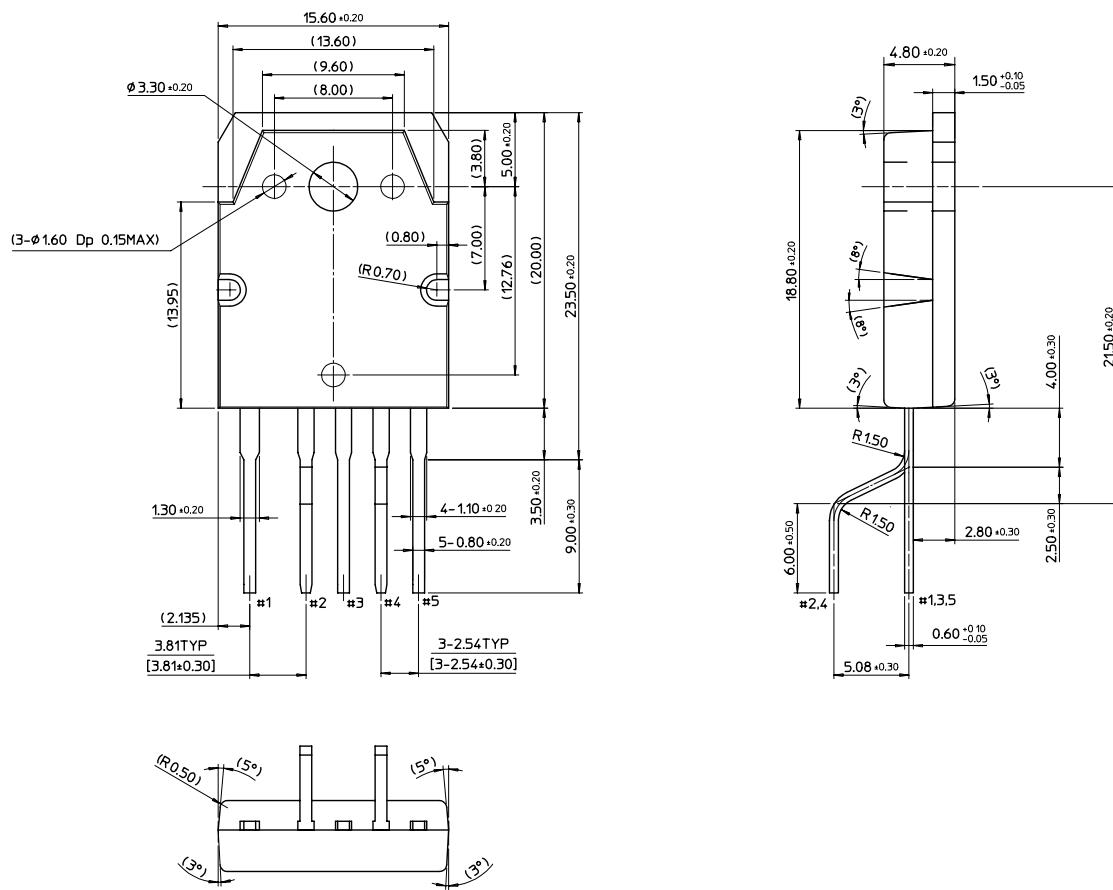
## Package Dimensions

### TO-3P-5L



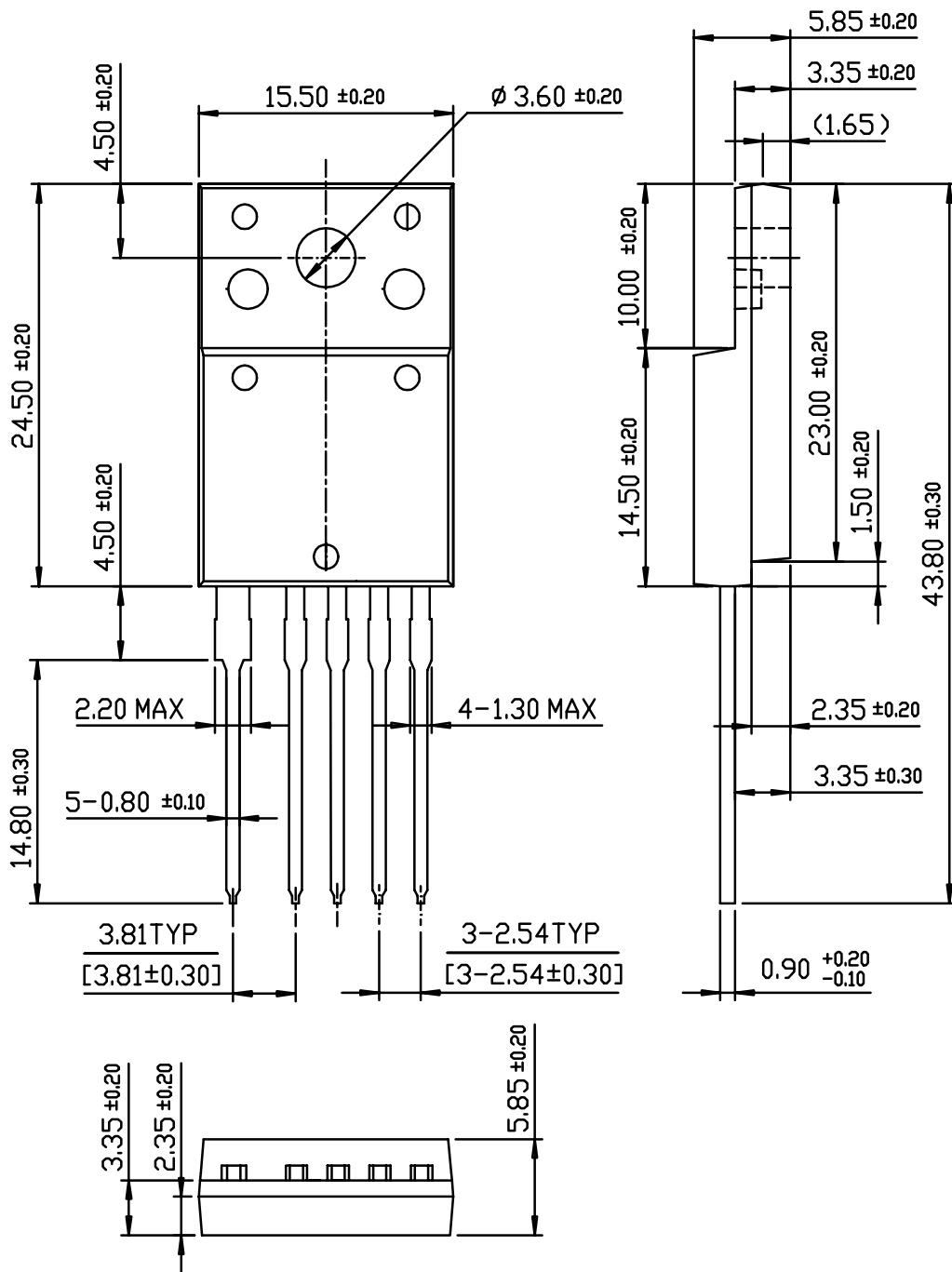
## Package Dimensions (Continued)

### TO-3P-5L (Forming)



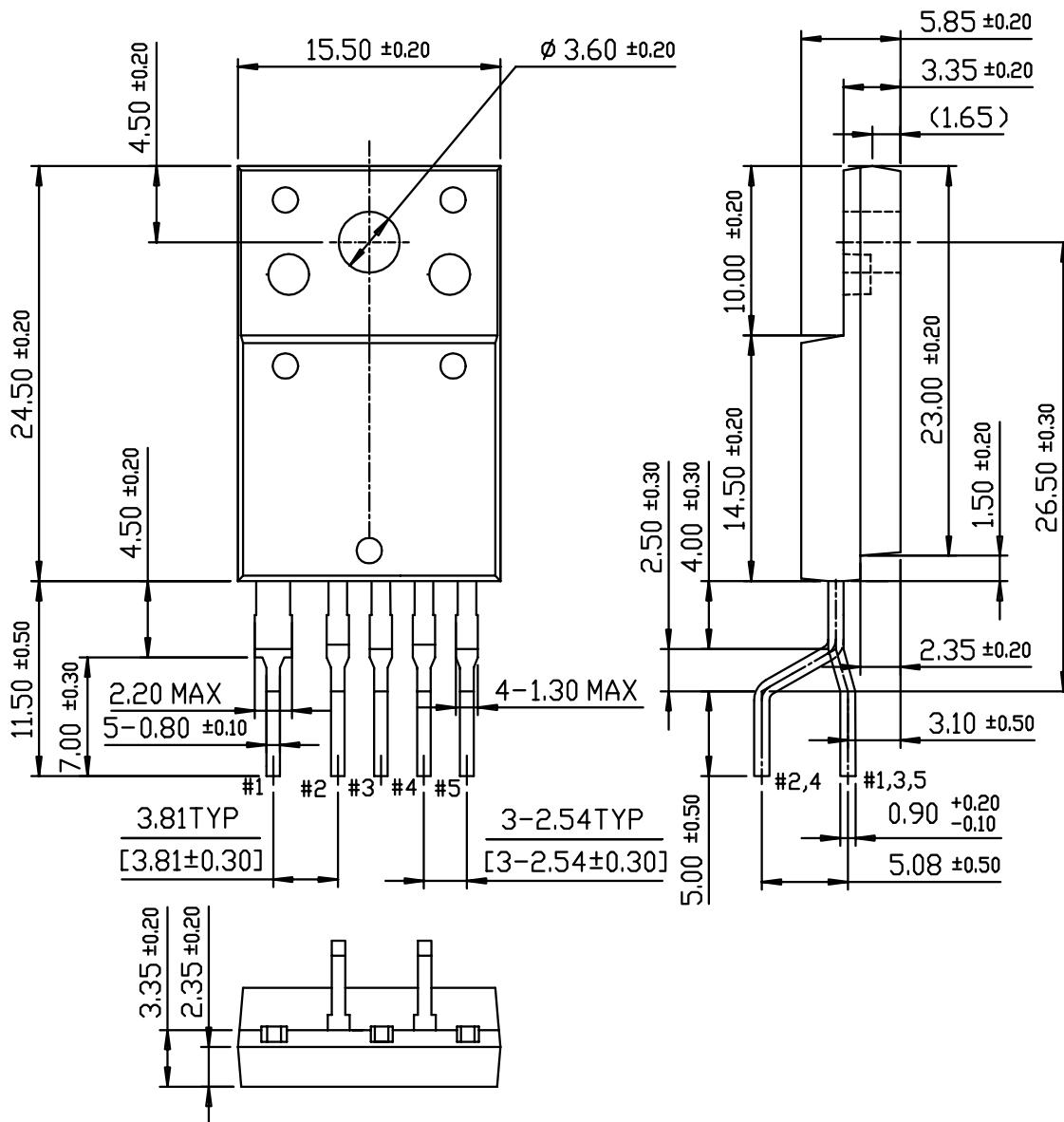
## Package Dimensions (Continued)

**TO-3PF-5L**



## Package Dimensions (Continued)

### TO-3PF-5L(Forming)



## Ordering Information

Product Number	Package	Rating	Fosc	Latch/Auto
KA1M0680B-TU	TO-3P-5L	800V, 6A	67kHz	Latch up mode
KA1M0680B-YDTU	TO-3P-5L(Forming)			
KA1M0680RB-TU	TO-3P-5L	800V, 6A	67kHz	Auto restart mode
KA1M0680RB-YDTU	TO-3P-5L(Forming)			
KA1H0680B-TU	TO-3P-5L	800V, 6A	100kHz	Latch up mode
KA1H0680B-YDTU	TO-3P-5L(Forming)			
KA1H0680RFB-TU	TO-3PF-5L	800V, 6A	100kHz	Auto restart mode
KA1H0680RFB-YDTU	TO-3PF-5L(Forming)			

TU : Non Forming Type

YDTU : Forming Type

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.